1-1775099-3 ACTIVE

ATX Power

TE Internal #: 1-1775099-3

PCB Mount Header, Vertical, Wire-to-Board, 24 Position, 1.4 mm [. 055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray,

ATX Power

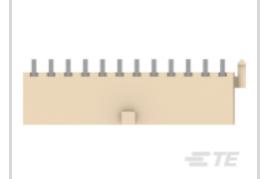
View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

Connector System: Wire-to-Board

Number of Positions: 24

Number of Rows: 2

Centerline (Pitch): 1.4 mm [.055 in]

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	24
Number of Rows	2
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	250 VAC
Body Features	
Primary Product Color	lvory

Contact Features



PCB Contact Termination Area Plating Material Thickness	3.05 μm[120.07 μin]
Contact Layout	Matrix
Mating Tab Width	1.14 mm[.044 in]
Mating Tab Thickness	1.1 mm[.043 in]
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	3.05 μm[120.07 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	9 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.55 mm[.021 in]
Rectangular Termination Post & Tail Width	1.14 mm[.044 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Alignment Type Mating Retention	Without
Mating Retention	Without
Mating Retention Connector Mounting Type	Without Board Mount
Mating Retention Connector Mounting Type Mating Alignment	Without Board Mount With
Mating Retention Connector Mounting Type Mating Alignment PCB Mount Alignment	Without Board Mount With With
Mating Retention Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention	Without Board Mount With With
Mating Retention Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features	Without Board Mount With With Without
Mating Retention Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material	Without Board Mount With Without With
Mating Retention Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch)	Without Board Mount With Without With
Mating Retention Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch) Dimensions	Without With Without With Without PA 9T 1.4 mm[.055 in]
Mating Retention Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch) Dimensions Row-to-Row Spacing	Without With Without With With 1.4 mm[.055 in]



Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | ATX Power



DVI Receptacles(3)

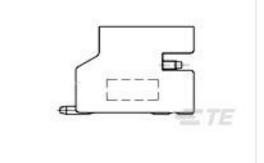


PCB Headers & Receptacles(32)

Customers Also Bought



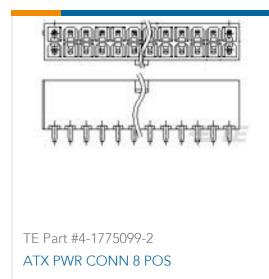
TE Part #1-5102154-2 A/L UNIV HDR 64P VERT



TE Part #1775469-3 HPI CONN., 2.0MM, R/A, SMT, 3P, 80U"



TE Part #5-103735-8
09 MTE HDR SRST LATCH .100CL





TE Part #9-2176307-8 RP 1E 0.1W 127K 0.1% 25PPM 5K RL



TE Part #1-2176364-2 RQ 0402 6K04 0.1% 10PPM 5K RL



TE Part #3-2176363-2 RQ 0402 909R 0.1% 10PPM 5K RL







Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1775099-3_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-1775099-3_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1775099-3_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

English